General Description

The MAX1422 3.3V, 12-bit analog-to-digital converter (ADC) features a fully differential input, pipelined, 12stage ADC architecture with wideband track-and-hold (T/H) and digital error correction incorporating a fully-differential signal path. The MAX1422 is optimized for lowpower, high dynamic performance applications in imaging and digital communications. The converter operates from a single 3.3V supply, consuming only 137mW while delivering a 67dB (typ) signal-to-noise ratio (SNR) at a 5MHz input frequency and a 20Msps sampling frequency. The fully-differential input stage has a small signal -3dB bandwidth of 400MHz and may be operated with single-ended inputs.

An internal 2.048V precision bandgap reference sets the ADCs full-scale range. A flexible reference structure accommodates an internally or externally applied buffered or unbuffered reference for applications requiring increased accuracy or a different input voltage range.

In addition to low operating power, the MAX1422 features two power-down modes, a reference power-down, and a shutdown mode. In reference power-down, the internal bandgap reference is deactivated, resulting in a 2mA (typ) supply current reduction. For idle periods, a full shutdown mode is available to maximize power savings.

The MAX1422 provides parallel, offset binary, CMOS-compatible three-state outputs.

The MAX1422 is available in a 7mm \times 7mm \times 1.4mm, 48-pin TQFP package and is specified over the commercial (0°C to +70°C) and extended industrial (-40°C to +85°C) temperature ranges.

Pin-compatible higher-speed versions of the MAX1422 are also available. Please refer to the MAX1421 data sheet for 40Msps and the MAX1420 data sheet for 60Msps.

Applications

Medical Ultrasound Imaging CCD Pixel Processing Data Acquisition Radar IF and Baseband Digitization

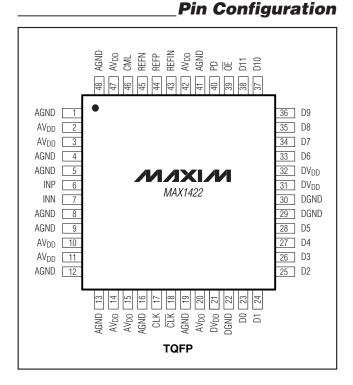
Functional Diagram appears at end of data sheet.

_Features

- Single 3.3V Power Supply
- ♦ 67dB SNR at f_{IN} = 5MHz
- Internal 2.048V Precision Bandgap Reference
- Differential Wideband Input T/H Amplifier
- ♦ Power-Down Modes
 130mW (Reference Shutdown Mode)
 10µW (Shutdown Mode)
- Space-Saving 48-Pin TQFP Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1422CCM	0°C to +70°C	48 TQFP
MAX1422ECM	-40°C to +85°C	48 TQFP



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

AV _{DD} , DV _{DD} to AGND	-0.3V to +4V
DV _{DD} , AV _{DD} to DGND	-0.3V to +4V
DGND to AGND	-0.3V to +0.3V
INP, INN, REFP, REFN, REFIN,	
CML,CLK, <u>CLK</u> ,	.(AGND - 0.3V) to (AV _{DD} + 0.3V)
D0–D11, OE, PD	$(DGND - 0.3V)$ to $(DV_{DD} + 0.3V)$
Continuous Power Dissipation ($(T_A = +70^{\circ}C)$

48-Pin TQFP (derate 21.7mW/°C al	oove +70°C)1739mW
Operating Temperature Ranges	
MAX1422CCM	0°C to +70°C
MAX1422ECM	40°C to +85°C
Maximum Junction Temperature	+150°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{AVDD} = V_{DVDD} = 3.3V, AGND = DGND = 0, V_{IN} = \pm 1.024V$, differential input voltage at -0.5dBFS, internal reference, f_{CLK} = 20MHz (50% duty cycle); digital output load C_L = 10pF, \geq +25°C guaranteed by production test, <+25°C guaranteed by design and characterization. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
DC ACCURACY		· · · · · · · · · · · · · · · · · · ·					
Resolution	RES			12		Bits	
		T _A = +25°C, no missing codes	-1		1		
Differential Nonlinearity	DNL	$T_A = T_{MIN}$ to T_{MAX}		±0.5		LSB	
Integral Nonlinearity	INL	$T_A = T_{MIN}$ to T_{MAX}		±2		LSB	
Mid-scale Offset	MSO		-3	±.75	3	%FSR	
Mid-scale Offset Temperature Coefficient	MSOTC			3×10 ⁻⁴		%/°C	
		Internal reference (Note 1)	-5	±0.1	5		
	GE	External reference applied to REFIN, (Note 2)	-5	±0.2	5		
Gain Error	GE	External reference applied to REFP, CML, and REFN (Note 3)	-1.5		1.5	- %FSR	
Gain Error Temperature Coefficient	GETC	External reference applied to REFP, CML, and REFN (Note 3)		15×10 ⁻⁶		%/°C	
DYNAMIC PERFORMANCE (f _{CL}	K = 20MHz, 4	096-point FFT)					
Signal-to-Noise Ratio	SNR	$f_{IN} = 5MHz$, $T_A = +25^{\circ}C$	63	67		dB	
Spurious-Free Dynamic Range	SFDR	$f_{IN} = 5MHz, T_A = +25^{\circ}C$	64	74		dBc	
Total Harmonic Distortion	THD	$f_{IN} = 5MHz, T_A = +25^{\circ}C$		-72	-63	dBc	
Signal-to-Noise and Distortion	SINAD	$f_{IN} = 5MHz, T_A = +25^{\circ}C$	60	65		dB	
Effective Number of Bits	ENOB	$f_{IN} = 5MHz$		10.5		Bits	
Two-Tone Intermodulation Distortion	IMD	$f_{IN1} = 7.028MHz$, $f_{IN2} = 8.093MHz$ (Note 4)		-77		dBc	
Differential Gain	DG			±1		%	
Differential Phase	DP			±0.25		Degrees	
ANALOG INPUTS (INP, INN, CM	L)	· · · · ·				•	
Input Resistance	R _{IN}	Either input to ground		61		kΩ	
Input Capacitance	CIN	Either input to ground		4		pF	
Common-Mode Input Level (Note 5)	V _{CML}			V _{AVDD} × 0.5		V	



ELECTRICAL CHARACTERISTICS (continued)

 $(V_{AVDD} = V_{DVDD} = 3.3V, AGND = DGND = 0, V_{IN} = \pm 1.024V$, differential input voltage at -0.5dBFS, internal reference, f_{CLK} = 20MHz (50% duty cycle); digital output load C_L = 10pF, \geq +25°C guaranteed by production test, <+25°C guaranteed by design and characterization. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN TYP MAX	UNITS
Common-Mode Input Voltage Range (Note 5)	V _{CMVR}		VCML ±5%	V
Differential Input Range	VIN	VINP - VINN (Note 6)	±VDIFF	V
Small-Signal Bandwidth	BW-3dB	(Note 7)	400	MHz
Large-Signal Bandwidth	FPBW -3dB	(Note 7)	150	MHz
Overvoltage Recovery	OVR	1.5× FS input	1	Clock cycles
INTERNAL REFERENCE (REFIN	bypassed wit	h 0.22µF in parallel with 1nF)		
Common-Mode Reference Voltage	VCML	At CML	V _{AVDD} × 0.5	V
Positive Reference Voltage	VREFP	At REFP	V _{CML} + 0.512	V
Negative Reference Voltage	VREFN	At REFN	V _{CML} - 0.512	V
Differential Reference Voltage	VDIFF	(Note 6)	1.024 ±5%	V
Differential Reference Temperature Coefficient	REFTC		±100	ppm/°C
EXTERNAL REFERENCE (VREFIN				
REFIN Input Resistance	R _{IN}	(Note 8)	5	kΩ
REFIN Input Capacitance	CIN		10	pF
REFIN Reference Input Voltage Range	VREFIN		2.048 ±10%	V
Differential Reference Voltage Range	VDIFF	(Note 6)	$\begin{array}{c} 0.92 \times \\ V_{\text{REFIN}/2} \end{array} V_{\text{REFIN}/2} & \begin{array}{c} 1.08 \times \\ V_{\text{REFIN}/2} \end{array}$	V
	N = 0, referen	ce voltage applied to REFP, REFN, and CML)	1	•
REFP, REFN, CML Input Current	l _{IN}		-200 200	μA
REFP, REFN, CML Input Capacitance	CIN		15	pF
Differential Reference Voltage Range	VDIFF	(Note 6)	1.024 ±10%	V
CML Input Voltage Range	VCML		1.65 ±10%	V
REFP Input Voltage Range	VREFP		V _{CML} + V _{DIFF} /2	V
REFN Input Voltage Range	VREFN		V _{CML} - V _{DIFF} /2	V
DIGITAL INPUTS (CLK, CLK, PD,	OE)			
Input Logic High	VIH		0.7 × V _{DVDD}	V
Input Logic Low	VIL		0.3 × V _{DVD}	V

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{AVDD} = V_{DVDD} = 3.3V, AGND = DGND = 0, V_{IN} = \pm 1.024V$, differential input voltage at -0.5dBFS, internal reference, f_{CLK} = 20MHz (50% duty cycle); digital output load C_L = 10pF, \geq +25°C guaranteed by production test, <+25°C guaranteed by design and characterization. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ΤΥΡ	MAX	UNITS
		CLK, CLK		±330		
Input Current		PD	-20		20	μA
		ŌĒ	-20		20	
Input Capacitance				10		pF
DIGITAL OUTPUTS (D0-D11)						
Output Logic High	V _{OH}	I _{OH} = 200μA	V _{DVDD} - 0.5		V _{DVDD}	V
Output Logic Low	V _{OL}	I _{OL} = -200µA	0		0.5	V
Three-State Leakage			-10		10	μA
Three-State Capacitance				2		pF
POWER REQUIREMENTS			·			
Analog Supply Voltage	VAVDD		3.138	3.3	3.465	V
Digital Supply Voltage	Vdvdd		2.7	3.3	3.63	V
Analog Supply Current	IAVDD			39	46	mA
Analog Supply Current with Internal Reference in Shutdown		V _{REFIN} = 0		37	44	mA
Analog Shutdown Current		$PD = DV_{DD}$			20	μA
Digital Supply Current	IDVDD			3		mA
Digital Shutdown Current		$PD = DV_{DD}$			20	μA
Power Dissipation	P _{DISS}	Analog power dissipation		137	152	mW
Power-Supply Rejection Ratio	PSRR	(Note 9)		±1		mV/V
TIMING CHARACTERISTICS						
Maximum Clock Frequency	fCLK	Figure 6	20			MHz
Clock High	tсн	Figure 6, clock period 50ns		25		ns
Clock Low	tCL	Figure 6, clock period 50ns		25		ns
Pipeline Delay (Latency)		Figure 6		7		Clock cycles
Aperture Delay	t _{AD}	Figure 10		2		ns
Aperture Jitter	taj	Figure 10		2		ps
Data Output Delay	tod	Figure 6	5	10	14	ns
Bus Enable Time	tBE	Figure 5		5		ns
Bus Disable Time	t _{BD}	Figure 5		5		ns

Note 1: Internal reference, REFIN bypassed to AGND with a combination of 0.22µF in parallel with 1nF capacitor.

Note 2: External 2.048V reference applied to REFIN.

Note 3: Internal reference disabled. VREFIN = 0, VREFP = 2.162V, VCML = 1.65V, and VREFN = 1.138V.

Note 4: IMD is measured with respect to either of the fundamental tones.

Note 5: Specifies the common-mode range of the differential input signal supplied to the MAX1422.

Note 6: VDIFF = VREFP - VREFN.

Note 7: Input bandwidth is measured at a 3dB level.

Note 8: VREFIN is internally biased to 2.048V through a $10k\Omega$ resistor.

Note 9: Measured as the ratio of the change in mid-scale offset voltage for a $\pm 5\%$ change in VAVDD, using the internal reference.



FFT PLOT (4096-POINT DATA RECORD) FFT PLOT (4096-POINT DATA RECORD) FFT PLOT (4096-POINT DATA RECORD) 0 0 0 f_{IN} = 5.2235MHz f_{IN} = 8.1637MHz f_{IN} = 19.8051MHz -20 -20 -20 -40 -40 AMPLITUDE (dB) AMPLITUDE (dB) -40 AMPLITUDE (dB) HD2 HD3 HD3 HD2 -60 HD2 -60 -60 HD? -80 -80 -80 -100 -100 -100 -120 -120 -120 6 9 3 4 5 6 0 2 3 4 5 7 8 9 10 0 1 2 3 4 5 6 7 8 10 0 1 2 7 8 9 10 ANALOG INPUT FREQUENCY (MHz) ANALOG INPUT FREQUENCY (MHz) ANALOG INPUT FREQUENCY (MHz) **TWO-TONE IMD PLOT SPURIOUS-FREE DYNAMIC RANGE vs.** SIGNAL-TO-NOISE RATIO vs. (4096-POINT DATA RECORD) ANALOG INPUT FREQUENCY ANALOG INPUT FREQUENCY 85 0 70 f_{IN1} = 7.0283MHz f_{IN2} = 8.0931MHz f_{CLK} = 20.0056MHz -20 77 66 $A_{IN1} = A_{IN2} = -6.5 dB FS$ f_{IN2} -40 AMPLITUDE (dB) 69 f_{IN1} (dBc) 62 SNR (dB) -60 SFDR (IMD2 61 58 IMD3 -80 53 54 -100 -120 45 50 0 2 3 4 5 6 7 8 9 1 10 10 100 100 1 10 1 ANALOG INPUT FREQUENCY (MHz) ANALOG INPUT FREQUENCY (MHz) ANALOG INPUT FREQUENCY (MHz) **SPURIOUS-FREE DYNAMIC RANGE** TOTAL HARMONIC DISTORTION vs. SIGNAL-TO-NOISE PLUS DISTORTION vs. ANALOG INPUT POWER (fin = 5MHz) ANALOG INPUT FREQUENCY vs. ANALOG INPUT FREQUENCY 80 -50 70 70 -56 66 60 50 SFDR (dBc) 62 -62 THD (dBc) SINAD (dB) 40 58 -68 30 20 -74 54 10 0 -80 50 -60 -50 -40 -30 -20 -10 0 10 100 1 10 100 1

ANALOG INPUT FREQUENCY (MHz)

Typical Operating Characteristics

 $(V_{AVDD} = V_{DVDD} = 3.3V, AGND = DGND = 0, V_{IN} = \pm 1.024V, differential input drive, A_{IN} = -0.5dBFS, f_{CLK} = 20MHz$ (50% duty cycle) digital output load C_L = 10pF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25 °C.)

ANALOG INPUT FREQUENCY (MHz)

ANALOG INPUT POWER (dB FS)

MAX1422

cycle) digital output load $C_L = 10$ pF, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.)

(VAVDD = VDVDD = 3.3V, AGND = DGND = 0, VIN = ±1.024V, differential input drive, AIN = -0.5dBFS, fCLK = 20MHz (50% duty

Typical Operating Characteristics (continued)

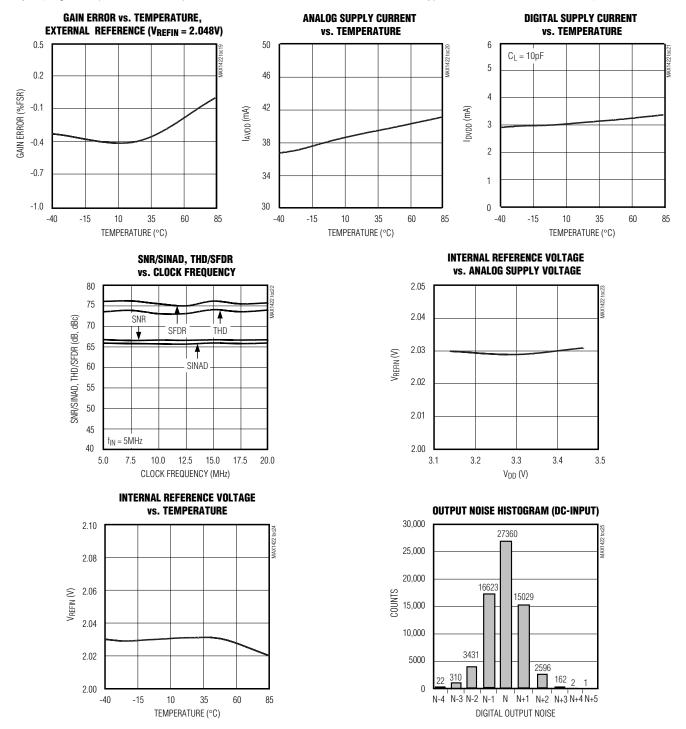
MAX1422

SIGNAL-TO-NOISE RATIO TOTAL HARMONIC DISTORTION SIGNAL-TO-NOISE PLUS DISTORTION vs. ANALOG INPUT POWER (fin = 5MHz) vs. ANALOG INPUT POWER (fin = 5MHz) vs. ANALOG INPUT POWER (fin = 5MHz) 100 -10 80 70 -20 AAX. 80 60 -30 50 60 SNR (dB) SINAD (dB) (dBc) -40 40 Ħ -50 40 30 -60 20 20 -70 10 0 -80 0 -60 -50 -40 -30 -20 -10 0 -60 -50 -40 -30 -20 -10 0 -60 -50 -40 -30 -20 -10 0 ANALOG INPUT POWER (dB FS) ANALOG INPUT POWER (dB FS) ANALOG INPUT POWER (dB FS) **SIGNAL-TO-NOISE RATIO TOTAL HARMONIC DISTORTION SPURIOUS-FREE DYNAMIC RANGE** vs. TEMPERATURE vs. TEMPERATURE vs. TEMPERATURE 70 -67 84 $f_{IN} = 5.5224 MHz$ f_{IN} = 5.5224MHz f_{IN} = 5.5224MHz 68 -69 80 SFDR (dBc) 66 -71 76 THD (dBc) SNR (dB) 64 -73 72 62 -75 68 60 -77 64 -40 -15 10 35 60 85 -40 -15 10 35 60 85 -40 -15 10 35 60 85 TEMPERATURE (°C) TEMPERATURE (°C) TEMPERATURE (°C) SIGNAL-TO-NOISE PLUS DISTORTION **INTEGRAL NONLINEARITY DIFFERENTIAL NONLINEARITY** vs. DIGITAL OUTPUT CODE vs. DIGITAL OUTPUT CODE vs. TEMPERATURE 2 0.50 70 $f_{IN} = 5.5224 MHz$ 68 0.25 SINAD (dB) DNL (LSB) 66 INL (LSB) 0 0 64 -0.25 -1 62 60 -2 -0.50 0 4096 0 1024 2048 3072 1024 2048 3072 4096 -15 35 60 85 -40 10 TEMPERATURE (°C) DIGITAL OUTPUT CODE DIGITAL OUTPUT CODE



Typical Operating Characteristics (continued)

 $(V_{AVDD} = V_{DVDD} = 3.3V, AGND = DGND = 0, V_{IN} = \pm 1.024V$, differential input drive, $A_{IN} = -0.5dBFS$, $f_{CLK} = 20MHz$ (50% duty cycle) digital output load $C_L = 10pF$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.)



M/XX/M

MAX1422

Pin Description

PIN	NAME	FUNCTION
1, 4, 5, 8, 9, 12, 13, 16, 19, 41, 48	AGND	Analog Ground. Connect all return paths for analog signals to AGND.
2, 3, 10, 11, 14, 15, 20, 42, 47	AV _{DD}	Analog Supply Voltage. For optimum performance, bypass to the closest AGND with a parallel combination of a 0.1μ F, and a 1nF capacitor. Connect a single 10μ F and 1μ F capacitor combination between AV _{DD} and AGND.
6	INP	Positive Analog Signal Input
7	INN	Negative Analog Signal Input
17	CLK	Clock Frequency Input. Clock frequency input ranges from 100kHz to 20MHz.
18	CLK	Complementary Clock Frequency Input. This input is used for differential clock input. If the ADC is driven with a single-ended clock, bypass CLK with 0.1µF capacitor to AGND.
21, 31, 32	DV _{DD}	Digital Supply Voltage. For optimum performance, bypass to the closest DGND with a parallel combination of a 0.1μ F and a 1nF capacitor. Connect a single 10μ F and 1μ F capacitor combination between DV _{DD} and DGND.
22, 29, 30	DGND	Digital Ground
23–28	D0-D5	Digital Data Outputs. Data bits D0 through D5, where D0 represents the LSB.
33–38	D6–D11	Digital Data Outputs. D6 through D11, where D11 represents the MSB.
39	ŌĒ	Output Enable Input. A logic "1" on \overline{OE} places the outputs D0–D11 into a high-impedance state. A logic "0" allows for the data bits to be read from the outputs.
40	PD	Shutdown Input. A logic "1" on PD places the ADC into shutdown mode.
43	REFIN	External Reference Input. Bypass to AGND with a capacitor combination of 0.22µF in parallel with 1nF. REFIN can be biased externally to adjust reference levels and calibrate full-scale errors. To disable the internal reference, connect REFIN to AGND.
44	REFP	Positive Reference I/O. Bypass to AGND with a capacitor combination of 0.22μ F in parallel with 1nF. With the internal reference disabled (REFIN = AGND), REFP should be biased toV _{CML} + V _{DIFF} /2.
45	REFN	Negative Reference I/O. Bypass to AGND with a capacitor combination of 0.22μ F in parallel with 1nF. With the internal reference disabled (REFIN = AGND), REFN should be biased to V _{CML} - V _{DIFF} /2.
46	CML	Common-Mode Level Input. Bypass to AGND with a capacitor combination of 0.22μ F in parallel with 1nF. With the internal reference disabled (REFIN = AGND), CML accepts an external voltage of 1.65V ±10%.

Detailed Description

The MAX1422 uses a 12-stage, fully differential, pipelined architecture (Figure 1), that allows for high-speed conversion while minimizing power consumption. Each sample moves through a pipeline stage every half-clock cycle. Including the delay through the output latch, the latency is seven clock cycles.

A 2-bit (2-comparator) flash ADC converts the held-input voltage into a digital code. The following digital-

to-analog converter (DAC) converts the digitized result back into an analog voltage, which is then subtracted from the original held-input signal. The resulting error signal is then multiplied by two and the product is passed along to the next pipeline stage. This process is repeated until the signal has been processed by all 12 stages. Each stage provides a 1-bit resolution. Digital error correction compensates for ADC comparator offsets in each pipeline stage and ensures no missing codes.



Input Track-and-Hold Transconductance Circuit

Figure 2 displays a simplified functional diagram of the input track-and-hold (T/H) circuit in both track-and-hold mode. In track mode, switches S1, S2a, S2b, S4a, S4b, S5a, and S5b are closed. The fully differential circuit samples the input signal onto the two capacitors (C2a and C2b) through-switches (S4a and S4b). Switches S2a and S2b set the common mode for the transconductance amplifier (OTA) input and open simultaneously with S1, sampling the input waveform. The resulting differential voltage is held on capacitors C2a and C2b. Switches S4a and S4b, are then opened before switches S3a and S3b connect capacitors C1a and C1b to the output of the amplifier, and switch S4c is closed. The OTA is used to charge capacitors, C1a and C1b, to the same values originally held on C2a and C2b. This value is then presented to the first stage quantizer and isolates the pipeline from the fast-changing input. The wide input bandwidth, T/H amplifier allows the MAX1422 to track and sample/hold analog inputs of high frequencies beyond Nyquist. The analog inputs INP and INN can be driven either differentially or single-ended. Match the impedance of INP and INN and set the common-mode voltage to midsupply (AV_{DD}/2) for optimum performance.

Analog Input and Reference Configuration

The full-scale range of the MAX1422 is determined by the internally generated voltage difference between REFP ($AV_{DD}/2 + V_{REFIN}/4$) and REFN ($AV_{DD}/2 - V_{REFIN}/4$). The MAX1422's full-scale range is adjustable through REFIN, which provides a high input impedance for this purpose. REFP, CML ($AV_{DD}/2$), and REFN are internally buffered, low impedance outputs.

The MAX1422 provides three modes of reference operation:

- Internal reference mode
- Buffered external reference mode
- Unbuffered external reference mode

In internal reference mode, the on-chip 2.048V bandgap reference is active and REFIN, REFP, CML, and REFN, left floating. For stability purposes bypass REFIN, REFP, REFN, and CML with a capacitor network of 0.22μ F, in parallel with a 1nF capacitor to AGND.

In buffered external reference mode, the reference voltage levels can be adjusted externally by applying a stable and accurate voltage at REFIN.

In unbuffered external reference mode, REFIN is connected to AGND, which deactivates the on-chip buffers of REFP, CML, and REFN. With their buffers shut down,

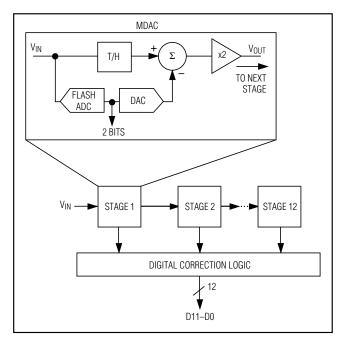


Figure 1. Pipelined Architecture

INTERNAL CML BIAS S5a S2a C1a S3a S4a OUT C2a -0 S4c S1 OTA -0 OUT 0 S4b C2b C1b S3b S2b S5b INTERNAL CML BIAS

Figure 2. Internal T/H Circuit



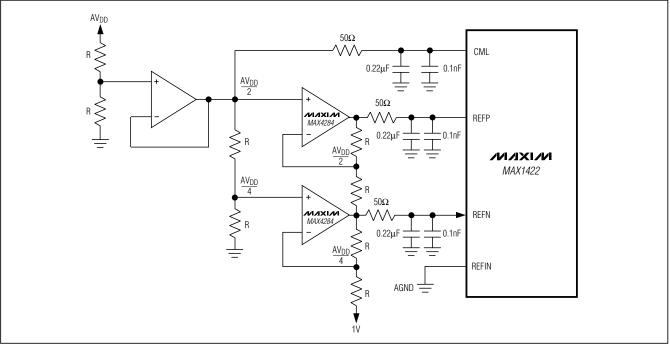


Figure 3. Unbuffered External Reference Drive—Internal Reference Disabled

these nodes become high impedance and can be driven by external reference sources, as shown in Figure 3.

Clock Inputs (CLK, CLK)

The MAX1422's CLK and $\overline{\text{CLK}}$ inputs accept both single-ended and differential input operation, and accept CMOS-compatible clock signals. If CLK is driven with a single-ended clock signal, bypass $\overline{\text{CLK}}$ with a 0.1µF capacitor to AGND. Since the interstage conversion of the device depends on the repeatability of the rising and falling edges of the external clock, use a clock with low jitter and fast rise and fall times (<2ns). In particular, sampling occurs on the rising edge of the clock signal, requiring this edge to have the lowest possible jitter. Any significant aperture jitter would limit the SNR performance of the ADC according to the following relationship:

$$SNR_{dB} = 20 \times \log_{10} \left(\frac{1}{2\pi \times f_{IN} \times t_{AJ}} \right)$$

where f_{IN} represents the analog input frequency, and t_{AJ} is the aperture jitter.

Clock jitter is especially critical for high input frequency applications. The clock input should always be consid-

ered as an analog input and routed away from any analog or digital signal lines.

The MAX1422 clock input operates with a voltage threshold set to AV_{DD}/2. Clock inputs must meet the specifications for high and low periods, as stated in the *Electrical Characteristics*.

Figure 4 shows a simplified model of the clock input circuit. This circuit consists of two $10k\Omega$ resistors to bias the common-mode level of each input. This circuit may be used to AC-couple the system clock signal to the MAX1422 clock input.

Output Enable (OE), Power-Down (PD) and Output Data (D0-D11)

With \overline{OE} high, the digital outputs enter a high-impedance state. If \overline{OE} is held low with PD high, the outputs are latched at the last value prior to the power-down.

All data outputs, D0 (LSB) through D11 (MSB), are TTL/CMOS logic compatible. There is a seven clock-cycle latency between any particular sample and its valid output data. The output coding is in offset binary format (Table 1).

The capacitive load on the digital outputs D0 through D11 should be kept as low as possible (\leq 10pF) to avoid large digital currents that could feed back into the ana-



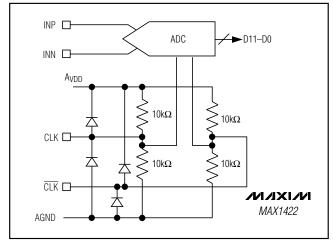


Figure 4. Simplified Clock Input Circuit

log portion of the MAX1421, thereby degrading its dynamic performance. The use of digital buffers (e.g. 74LVCH16244) on the digital outputs of the ADCs can further isolate the digital outputs from heavy capacitive loads. To further improve the MAX1422 dynamic performance, add small 100 Ω series resistors to the digital output paths, close to the ADC. Figure 5 displays the timing relationship between output enable and data output.

System Timing Requirements

Figure 6 depicts the relationship between the clock input, analog input, and data output. The MAX1422 samples the analog input signal on the rising edge of CLK (falling edge of CLK). and output data is valid seven clock cycles (latency) later. Figure 6 also displays the relationship between the input clock parameters and the valid output data.

Applications Information

Figure 7 depicts a typical application circuit containing a single-ended to differential converter. The internal reference provides an AV_{DD}/2 output voltage for level-shifting purposes. The input is buffered and then split to a voltage follower and inverter. A lowpass filter at the input suppresses some of the wideband noise associated with high-speed op amps. Select the R_{ISO} and C_{IN} values to optimize the filter performance and to suit a particular application. For the application in Figure 7, a R_{ISO} of 50 Ω is placed before the capacitive load to prevent ringing and oscillation. The 22pF C_{IN} capacitor acts as a small bypassing capacitor.Connecting C_{IN} from INN to INP may further improve dynamic performance.

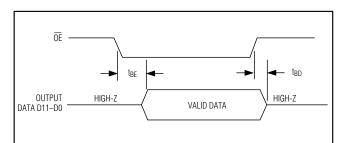


Figure 5. Output Enable Timing

Table 1. MAX1422 Output Code ForDifferential Inputs

DIFFERENTIAL INPUT VOLTAGE*	DIFFERENTIAL INPUT	OFFSET BINARY		
V _{REF} × 2047/2048	+FULL SCALE - 1LSB	1111 1111 1111		
V _{REF} × 2046/2048	+FULL SCALE - 2LSB	1111 1111 1110		
V _{REF} × 1/2048	+1 LSB	1000 0000 0001		
0	Bipolar Zero	1000 0000 0000		
-V _{REF} × 1/2048	-1 LSB	0111 1111 1111		
-V _{REF} × 2046/2048	-FULL SCALE +1 LSB	0000 0000 0001		
-V _{REF} × 2047/2048	-FULL SCALE	0000 0000 0000		

*V_{REF} = V_{REFP} - V_{REFN}

Using Transformer Coupling

An RF transformer (Figure 8) provides an excellent solution to convert a single-ended signal to a fully differential signal, required by the MAX1422 for optimum performance. Connecting the center tap of the transformer to CML provides an $AV_{DD}/2$ DC level shift to the input. Although a 1:1 transformer is shown, a 1:2 or 1:4 step-up transformer may be selected to reduce the drive requirements.

In general, the MAX1422 provides better SFDR and THD with fully differential input signals over singleended input signals, especially for very high input frequencies. In differential input mode, even-order harmonics are suppressed and each of the inputs requires only half the signal swing compared to singleended mode.





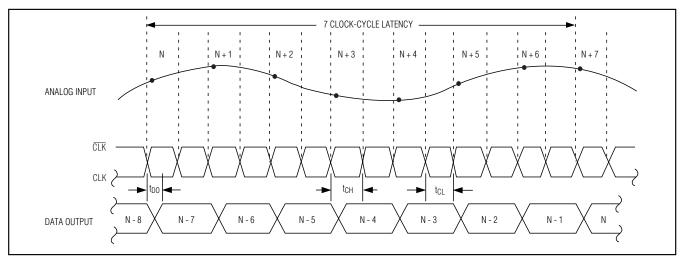


Figure 6. System and Output Timing Diagram

Single-Ended, AC-Coupled Input Signal

Figure 9 shows an AC-coupled, single-ended application, using a MAX4108 op amp. This configuration provides high-speed, high-bandwidth, low noise, and low distortion to maintain the integrity of the input signal.

Grounding, Bypassing and Board Layout

The MAX1422 requires high-speed board layout design techniques. Locate all bypass capacitors as close to the device as possible, preferably on the same side of the board as the ADC, using surface-mount devices for minimum inductance. Bypass REFP, REFN, REFIN, and CML with a parallel network of 0.22µF capacitors and 1nF to AGND. AVDD should be bypassed with a similar network of a 10µF bipolar capacitor in parallel with two ceramic capacitors of 1nF and 0.1µF. Follow the same rules to bypass the digital supply DV n to DGND. Multilayer boards with separate ground and power planes produce the highest level of signal integrity. Consider the use of a split ground plane arrangement to match the physical location of the analog ground (AGND) and the digital output driver ground (DGND) on the ADCs package. The two ground planes should be joined at a single point such that the noisy digital ground currents do not interfere with the analog ground plane. Alternatively, all ground pins could share the

same ground plane if the ground plane is sufficiently isolated from any noisy, digital systems ground plane (e.g., downstream output buffer DSP ground plane). Route high-speed digital signal traces away from sensitive analog traces, and remove digital ground and power planes from underneath digital outputs. Keep all signal lines short and free of 90 degree turns.

Static Parameter Definitions

Integral Nonlinearity (INL)

Integral nonlinearity is the deviation of the values on an actual transfer function from a straight line. This straight-line can be either a best straight-line fit or a line drawn between the endpoints of the transfer function, once offset and gain errors have been nullified. The static linearity parameters for the MAX1422 are measured using the best straight-line fit method.

Differential Nonlinearity (DNL)

Differential nonlinearity is the difference between an actual step-width and the ideal value of 1LSB. A DNL error specification of less than 1LSB guarantees no missing codes.

Dynamic Parameter Definitions

Aperture Jitter

Figure 10 depicts the aperture jitter (t_{AJ}) , which is the sample-to-sample variation in the aperture delay.



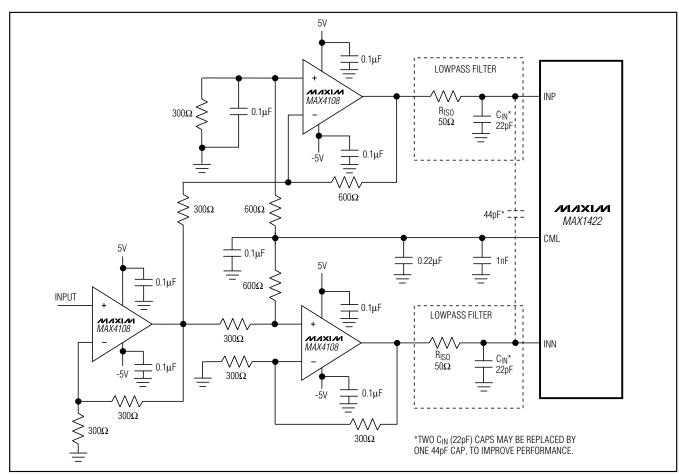


Figure 7. Typical Application Circuit for Single-Ended to Differential Conversion

Aperture Delay

Aperture delay (t_{AD}) is the time defined between the falling edge of the sampling clock and the instant when an actual sample is taken (Figure 10).

Signal-to-Noise Ratio (SNR)

For a waveform perfectly reconstructed from digital samples, the theoretical maximum SNR is the ratio of the full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical, minimum analog-to-digital noise is caused by quantization error only and results directly from the ADCs resolution (N-Bits):

$$SNR(MAX) = (6.02 \times N + 1.76) dB$$

In reality, there are other noise sources besides quantization noise e.g., thermal noise, reference noise, clock jitter, etc. SNR is computed by taking the ratio of the RMS signal to the RMS noise, which includes all spectral components minus the fundamental, the first four harmonics, and the DC offset.

Signal-to-Noise Plus Distortion (SINAD)

SINAD is computed by taking the ratio of the RMS signal to all spectral components minus the fundamental and the DC offset.

Effective Number of Bits (ENOB)

ENOB specifies the dynamic performance of an ADC at a specific input frequency and sampling rate. An ideal ADCs error consists of quantization noise only. ENOB is computed from:

$$ENOB = \frac{SINAD - 1.76}{6.02}$$

Total Harmonic Distortion (THD)

THD is typically the ratio of the RMS sum of the first four harmonics of the input signal to the fundamental itself. This is expressed as:

$$\left(\text{THD} = 20 \times \log_{10} \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2}}{V_1}\right)$$

where V_1 is the fundamental amplitude, and V_2 through V_5 are the amplitudes of the 2nd- through 5th-order harmonics.

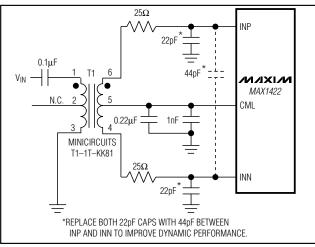


Figure 8. Using a Transformer for AC-Coupling

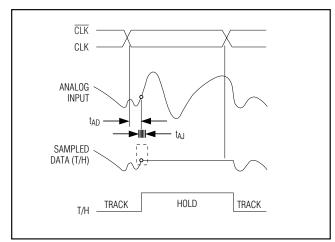


Figure 10. T/H Aperature Timing

Spurious-Free Dynamic Range (SFDR)

SFDR is the ratio expressed in decibels of the RMS amplitude of the fundamental (maximum signal component) to the RMS value of the next largest spurious component, excluding DC offset.

Intermodulation Distortion (IMD)

The two-tone IMD is the ratio expressed in decibels of either input tone to the worst 3rd-order (or higher) intermodulation products. The individual input tone levels are at -6.5dB full scale.

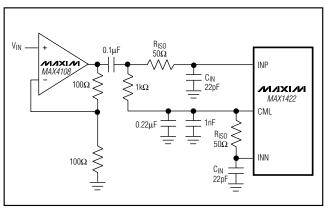
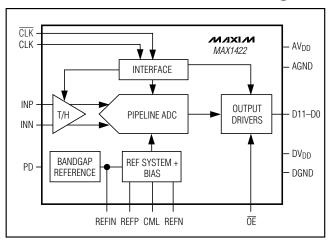


Figure 9. Single-Ended AC-Coupled Input



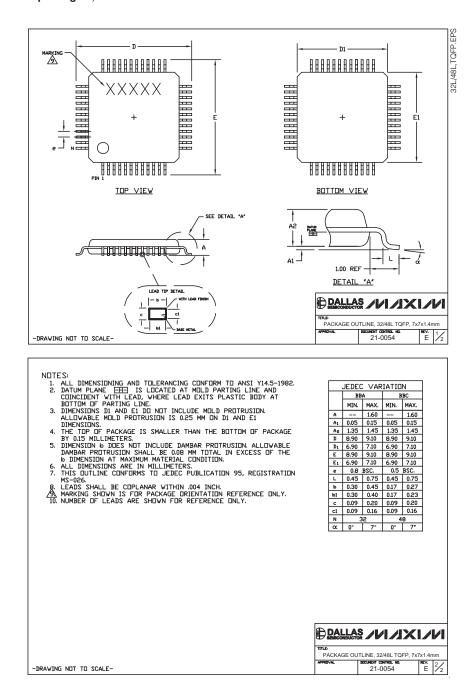
Functional Diagram



MAX1422

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Printed USA

© 2004 Maxim Integrated Products

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Maxim Integrated:

MAX16909RAUE/V+ MAX16909RAUE/V+T MAX16909RATE/V+ MAX16909RATE/V+T MAX1422CCM+D MAX1422CCM+TD